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# **2D Photonic Materials and Devices**

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*Editors*

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# Contents

v	<i>Authors</i>
vii	<i>Conference Committee</i>

---

## **GROWTH AND PHYSICS OF 2D MATERIALS I**

---

10534 06	<b>Plasmon enhanced light emission in molybdenum disulfide [10534-5]</b>
----------	--

---

## **2D MATERIAL INTEGRATED PHOTONIC DEVICES I**

---

10534 0E	<b>Recent progress on the scalable fabrication of hybrid polymer/SiO<sub>2</sub> nanophotonic cavity arrays with an encapsulated MoS<sub>2</sub> film [10534-13]</b>
10534 0F	<b>Coupling single defects in 2D semiconductor to a silver nanowire [10534-14]</b>



## Authors

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Aghaeimeibodi, Shahriar, 0F  
Bartels, Ludwig, 0E  
Cai, Tao, 0F  
D'Souza, F., 06  
Dutta, Subhojit, 0F  
Fourkas, John T., 0F  
Hammer, Sebastian, 0E  
Krenner, Hubert J., 0E  
Mangold, Hans-Moritz, 0E  
Martinez-Ta, Dominic, 0E  
Naghbi Alvillar, Sahar, 0E  
Nah, Sanghee, 0F  
Neogi, A., 06  
Nguyen, Ariana E., 0E  
Poudel, Y., 06  
Waks, Edo, 0F  
Yang, Zhili, 0F



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- 2 Growth and Physics of 2D Materials II  
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- 3 2D Material Integrated Photonic Devices I  
**Arka Majumdar**, University of Washington (United States)

- 4 2D Material Integrated Photonic Devices II  
**Vinod M. Menon**, The City College of New York (United States)
- 5 2D Material Integrated Photonic Devices III  
**Arka Majumdar**, University of Washington (United States)
- 6 2D Material Integrated Photonic Devices IV  
**Alexander I. Tartakovskii**, The University of Sheffield (United Kingdom)